



Customer Information Notification

202304012I : MKE17/13/12Z256/128VLL7 Final Test Site Expansion from NXP-ATTJ B2 to NXP-ATKL

Note: This notice is NXP Company Proprietary.

Issue Date: Jun 09, 2023 **Effective date:** Jun 10, 2023

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Management summary

Final Test site expansion for the MKE17/13/12Z256/128VLL7 14x14 100LQFP to the NXP-ATKL, Kuala Lumpur, Malaysia Final Test site.

Change Category

<input type="checkbox"/> Wafer Fab Process	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Product Marking	<input type="checkbox"/> Test Process	<input type="checkbox"/> Design
<input type="checkbox"/> Wafer Fab Materials	<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Equipment	<input type="checkbox"/> Errata
<input type="checkbox"/> Wafer Fab Location	<input type="checkbox"/> Assembly Location	<input type="checkbox"/> Packing/Shipping/Labeling	<input checked="" type="checkbox"/> Test Location	<input type="checkbox"/> Electrical spec./Test coverage
<input type="checkbox"/> Firmware	<input type="checkbox"/> Other			

PCN Overview

Description

NXP Semiconductors announces the Final Test site expansion for the MKE17/13/12Z256/128VLL7 14X14 100LQFP associated with this notification, from the current NXP-ATTJ B2, Tianjin, China Final Test site to the NXP-ATKL, Kuala Lumpur, Malaysia Final Test site. The associated Test Backend Shipping / Packing Operations expand to the NXP-ATKL site as well.

Final Test site expansion was successfully qualified adhering to NXP specifications.

Please see the attached file(s) for additional details.

Reason

Qualification of NXP-ATKL, Kuala Lumpur, Malaysia is required for manufacturing flexibility and customer supply assurance.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Disposition of Old Products

NXP-ATKL will be an additional final test site. Products may continue to be tested at NXP-ATTJ as well.

Additional information

Additional documents: [view online](#)

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team.

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